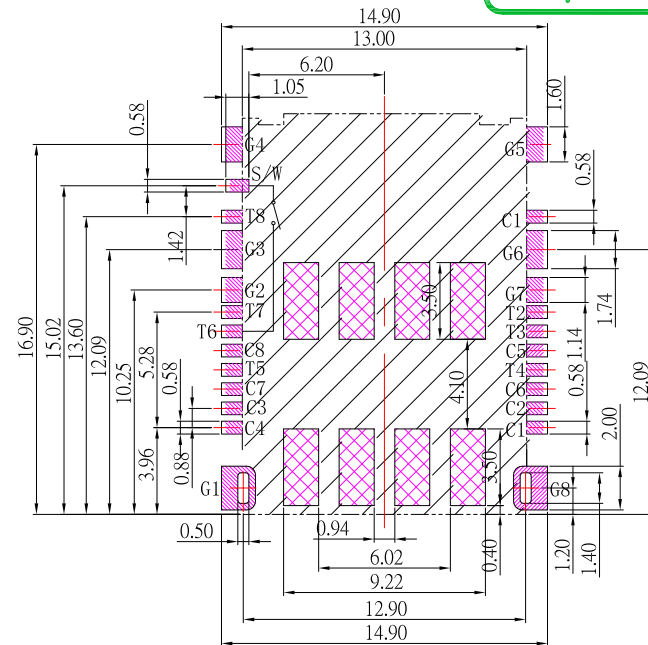
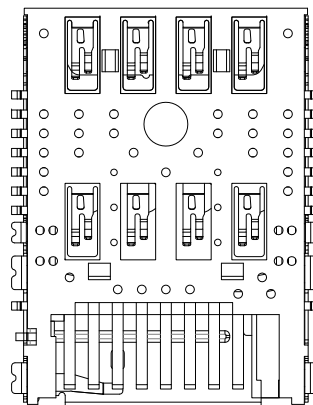
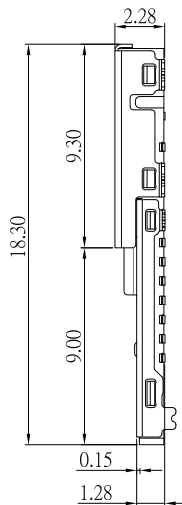
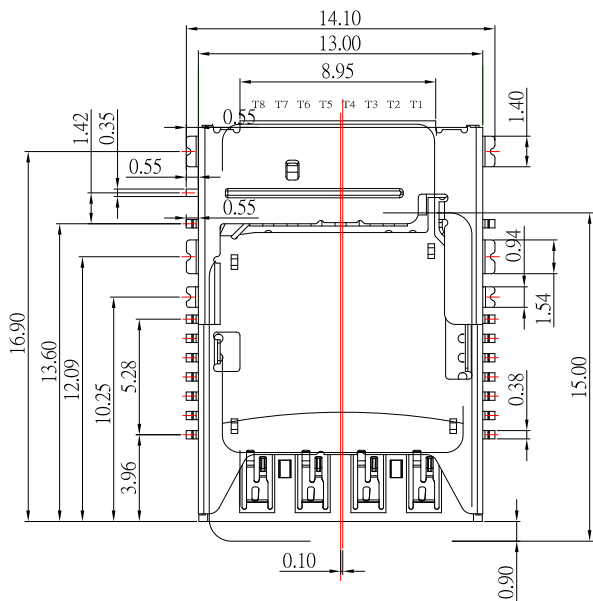




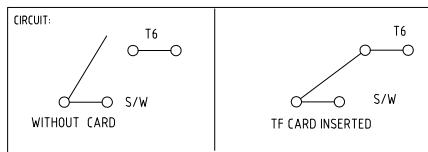
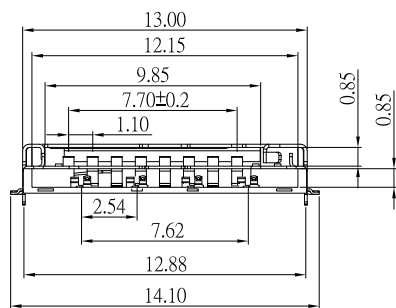
PCB LAYOYT

TF CARD PIN ASSIGNMENT

PIN NO.	PIN ASSIGNMENT
T1	DAT2
T2	CD/DAT3 ²
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

SIM pin assignment

	Name
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



SPECIFICATION

Electrical :

- 1.Current Rating: 0.5A , AC/DC
- 2.Contact Resistance: 100 mΩ Max.
- 3.Insulation Resistance: 500 MΩ Min.

Environmental:

- 1.Operating Temperature: -20°C ~ +85°C.

Material:

- 1.Housing: LCP
 - 2.Contact: Copper Alloy
 - 3.Shell: Stainless Steel
- Finish:
- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
 - 2.Shell: Nickel under Plated surface layer



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TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE
04/24/20
DATE
04/24/20
DATE
04/24/20

MAT'L
FINISH
SCALE
SHEET NO.

TITLE
MODLE
DWG NO.
PART NO.

CONNECTOR
MICRO SD + MICRO SIM 卡座二合一
MSISD-003-S267
MSISD-003-S267

SIZE
A4
VER
R1

ITEM NO	DESCRIPTION	DRAWN	DATE
1	更新圖面	Jack	042420